Unit: mm

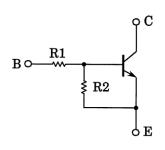
TOSHIBA Transistor Silicon NPN Epitaxial Type (PCT Process) (Bias Resistor built-in Transistor)

# **RN1101MFV, RN1102MFV, RN1103MFV** RN1104MFV, RN1105MFV, RN1106MFV

Switching, Inverter Circuit, Interface Circuit and **Driver Circuit Applications** 

- Ultra-small package, suited to very high density mounting
- Incorporating a bias resistor into the transistor reduces the number of parts, so enabling the manufacture of ever more compact equipment and lowering assembly cost.
- A wide range of resistor values is available for use in various circuits.
- Complementary to the RN2101MFV to RN2106MFV

### **Equivalent Circuit and Bias Resistor Values**



Type No.	R1 (kΩ)	R2 (kΩ)
RN1101MFV	4.7	4.7
RN1102MFV	10	10
RN1103MFV	22	22
RN1104MFV	47	47
RN1105MFV	2.2	47
RN1106MFV	4.7	47

# $1.2 \pm 0.05$ $0.32 \pm 0.05$ 1. BASE 2. EMITTER **VESM** 3. COLLECTOR **JEDEC** JEITA TOSHIBA 2-1L1A

Weight: 1.5 mg (typ.)

## **Absolute Maximum Ratings (Ta = 25°C)**

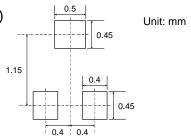
Characte	Symbol	Rating	Unit		
Collector-base voltage	RN1101MFV to 1106MFV	Vсво	50	V	
Collector-emitter voltage	RIVITOTIVIEV TO LIDOVIEV	VCEO	50	V	
Emitter-base voltage	RN1101MFV to 1104MFV	\/==0	10	V	
	RN1105MFV, 1106MFV	V <sub>EBO</sub>	5		
Collector current		Ic	100	mA	
Collector power dissipation	RN1101MFV to 1106MFV	P <sub>C</sub> (Note 1)	150	mW	
Junction temperature	KINTTOTIVIEV TO TTUDIVIEV	Tj	150	°C	
Storage temperature range		T <sub>stg</sub>	−55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook

("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on an FR4 board (25.4 mm × 25.4 mm × 1.6 mm)

#### Pad Dimension (Reference)



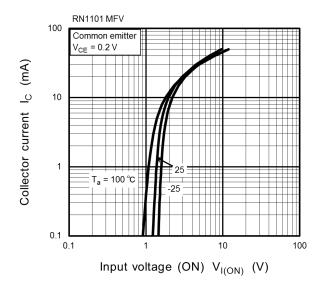
Start of commercial production 2005-02

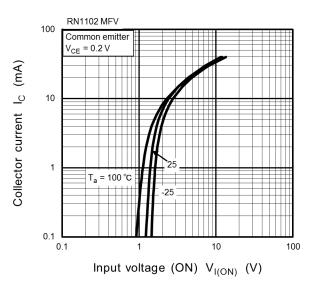


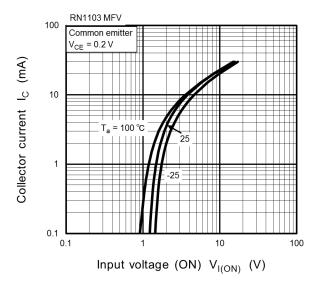
## Electrical Characteristics (Ta = 25°C)

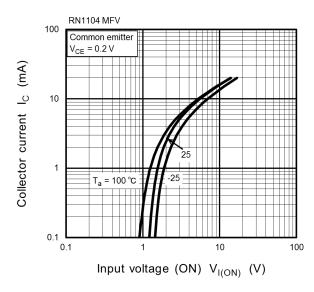
Charac	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cutoff current	RN1101MFV to	ICBO	VCB = 50 V, IE = 0 A	_	_	100	20
	RN1106MFV		V <sub>CE</sub> = 50 V, I <sub>B</sub> = 0 A	_	_	500	nA
	RN1101MFV	I	VEB = 10 V, IC = 0 A	0.82	_	1.52	- mA
	RN1102MFV			0.38	_	0.71	
Emitter cutoff current	RN1103MFV			0.17	_	0.33	
Limiter cuton current	RN1104MFV	I <sub>EBO</sub>		0.082	_	0.15	
	RN1105MFV		V <sub>EB</sub> = 5 V, I <sub>C</sub> = 0 A	0.078	_	0.145	
	RN1106MFV			0.074	_	0.138	
	RN1101MFV			30	_	_	
	RN1102MFV			50	_	_	
DC accept a sign	RN1103MFV	h	\\\ \(\Gamma\)	70	_	_	
DC current gain	RN1104MFV	hFE	VCE = 5 V, IC = 10 mA	80	_	_	_
	RN1105MFV			80	_	_	
	RN1106MFV			80	_	_	
Collector-emitter saturation voltage	RN1101MFV to RN1106MFV	VCE (sat)	I <sub>C</sub> = 5 mA, I <sub>B</sub> = 0.5 mA	_	0.1	0.3	V
	RN1101MFV		V <sub>CE</sub> = 0.2 V, I <sub>C</sub> = 5 mA	1.1	_	2.0	V
Input voltage (ON)	RN1102MFV	VI (ON)		1.2	_	2.4	
	RN1103MFV			1.3	_	3.0	
	RN1104MFV			1.5	_	5.0	
	RN1105MFV			0.6	_	1.1	
	RN1106MFV			0.7	_	1.3	
Input voltage (OFF)	RN1101MFV to RN1104MFV	.,	V <sub>CE</sub> = 5 V, I <sub>C</sub> = 0.1 mA	1.0	_	1.5	V
	RN1105MFV, RN1106MFV	VI (OFF)		0.5	_	0.8	
Collector output capacitance	RN1101MFV to RN1106MFV	Cob	$V_{CB} = 10 \text{ V}, I_{E} = 0 \text{ A},$ $f = 1 \text{ MH}_{Z}$	_	0.7	_	pF
Input resistor	RN1101MFV		_	3.29	4.7	6.11	kΩ
	RN1102MFV	R1		7	10	13	
	RN1103MFV			15.4	22	28.6	
	RN1104MFV			32.9	47	61.1	
	RN1105MFV			1.54	2.2	2.86	
	RN1106MFV	1		3.29	4.7	6.11	
Resistor ratio	RN1101MFV to RN1104MFV	R1/R2	_	0.8	1.0	1.2	_
	RN1105MFV			0.0376	0.0468	0.0562	
	RN1106MFV			0.08	0.1	0.12	

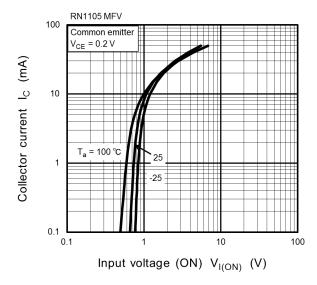
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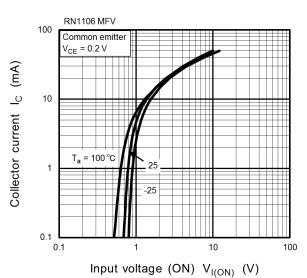




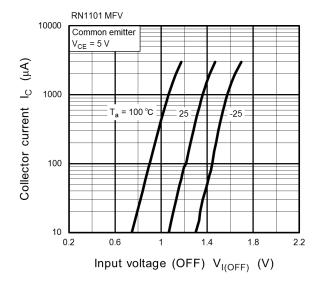


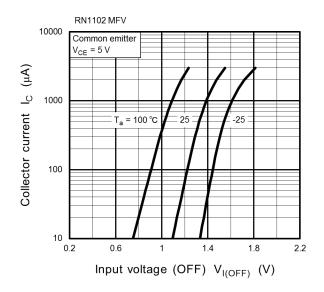


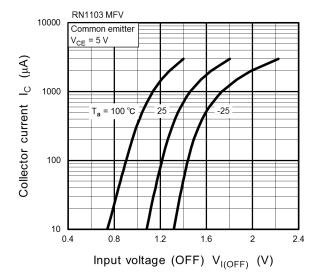


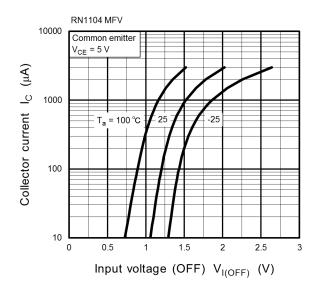


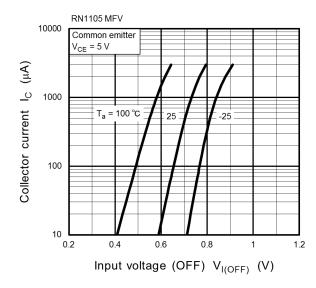
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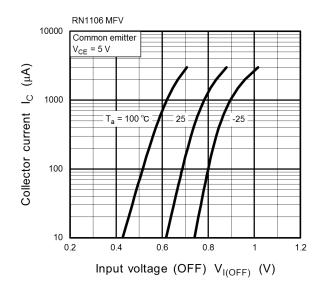


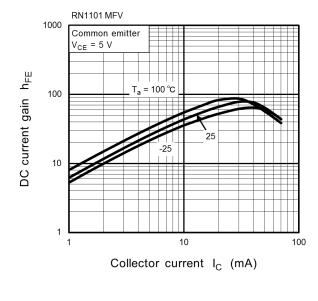


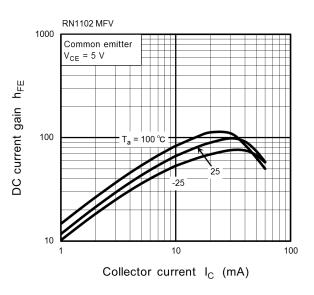


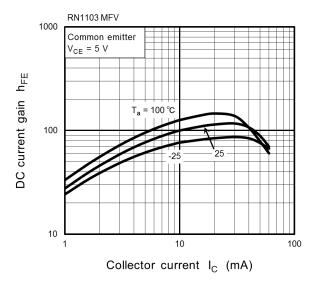


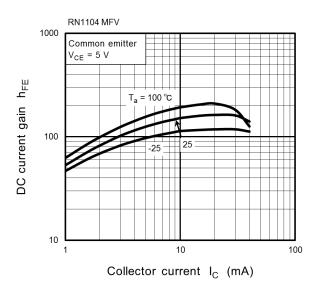


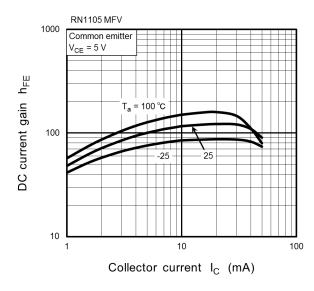


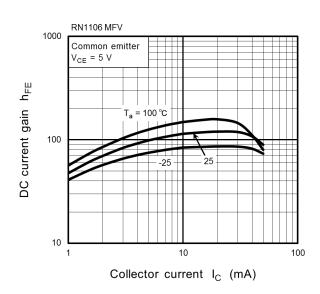


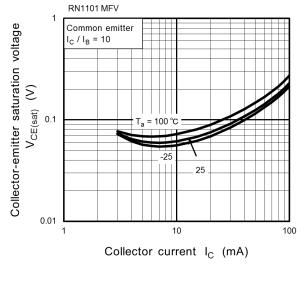


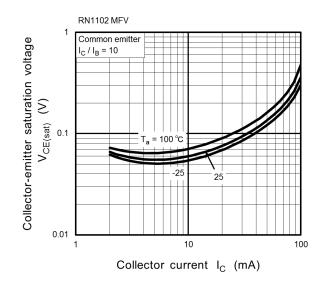


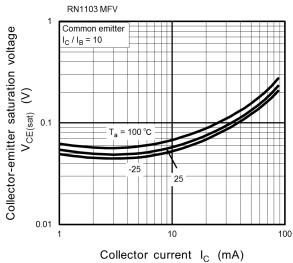


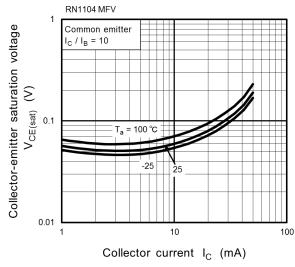


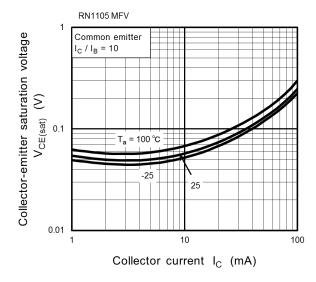


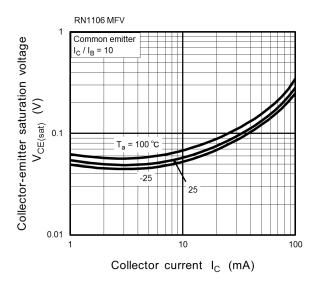












Type Name	Marking
RN1101MFV	Type Name  XA
RN1102MFV	Type Name
RN1103MFV	Type Name
RN1104MFV	Type Name
RN1105MFV	Type Name
RN1106MFV	Type Name

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